

### **Features**

Power Dissipation

P<sub>CM</sub>: 1 W (T<sub>a</sub>=25°C)



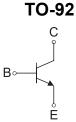
2. BASE

3. COLLECTOR



**Package Marking and Ordering Information** 

Product ID	Pack	Marking	Qty(PCS)
SS8050	TO-92	х	1000



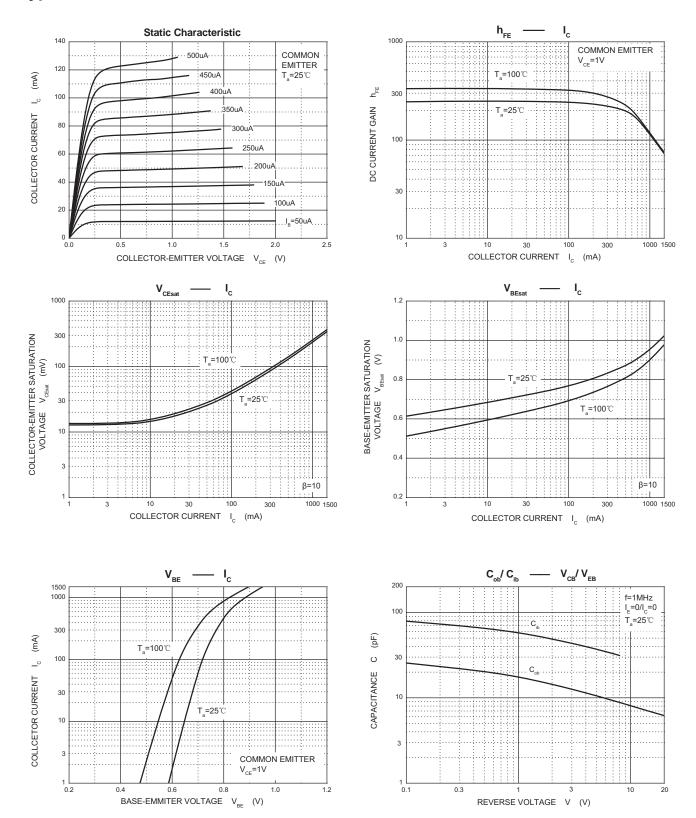
Maximum Ratings (Ta=25°C unless otherwise noted)

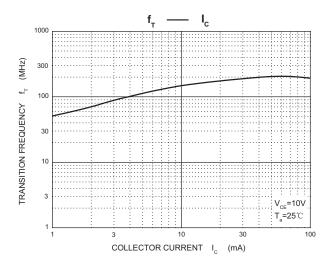
Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	40	V
V <sub>CEO</sub>	Collector-Emitter Voltage	25	V
V <sub>EBO</sub>	Emitter-Base Voltage	5	V
Ic	Collector Current -Continuous	1.5	А
P <sub>D</sub>	Collector Power Dissipation	1.0	W
R <sub>0 JA</sub>	Thermal Resistance From Junction to Ambient	125	°C /W
$T_J, T_{stg}$	Operation Junction and Storage Temperature Range	-55~+150	$^{\circ}$

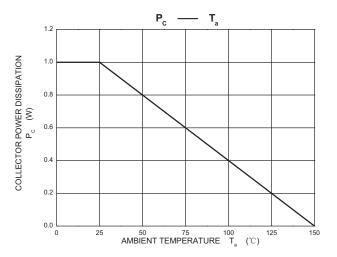
# Electrical Characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> =100uA, I <sub>E</sub> =0	40			V
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> =0.1mA, I <sub>B</sub> =0	25			V
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> =100μA, I <sub>C</sub> =0	5			V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> =40V, I <sub>E</sub> =0			0.1	μA
Emitter cut-off current	I <sub>CEO</sub>	V <sub>CE</sub> =20V, I <sub>E</sub> =0			0.1	μΑ
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> =5V, I <sub>C</sub> =0			0.1	μΑ
DC current gain	h <sub>FE(1)</sub>	V <sub>CE</sub> =1V, I <sub>C</sub> =100mA	160		300	
Do current gain	h <sub>FE(2)</sub>	V <sub>CE</sub> =1V, I <sub>C</sub> =800mA	40			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =800mA, I <sub>B</sub> =80mA			0.5	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> =800mA, I <sub>B</sub> =80mA			1.2	V
Base-emitter voltage	V <sub>BE</sub>	V <sub>CE</sub> =1V, I <sub>C</sub> =10mA			1	V
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> =10V, I <sub>C</sub> =50mA,f=30MH <sub>Z</sub>	100			MHz

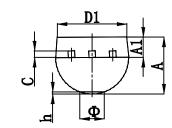
### **Typical Characteristics**

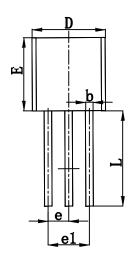






## **TO-92 Package Outline Dimensions**





Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	3.300	3.700	0.130	0.146	
A1	1.100	1.400	0.043	0.055	
b	0.380	0.550	0.015	0.022	
С	0.360	0.510	0.014	0.020	
D	4.300	4.700	0.169	0.185	
D1	3.430		0.135		
E	4.300	4.700	0.169	0.185	
е	1.270 TYP		0.050 TYP		
e1	2.440	2.640	0.096	0.104	
L	14.100	14.500	0.555	0.571	
Ф		1.600		0.063	
h	0.000	0.380	0.000	0.015	



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